

PATENT 87552.99R134/SE-906D

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

#5 185 1-13-00 R. Stokes

Applicant:

Jack H. Linn, et al.

) Examiner:

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Honorable Commissioner of Patents and Trademarks

Washington, D.C. 20231

TECHNOLOGY CENTER 2800

Dear Sir:

Applicant hereby brings to the attention of the United States Patent and Trademark Office, the references listed on the attached Form PTO-1449. Copies are not included since these references are of record in Applicant's parent application.

If any additional fees are required, please charge Deposit Account No. 10-0223.

Respectfully submitted,

Date

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